

AM3962N-T1-PF-VB Datasheet Dual N-Channel 60 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a Q _g (Ty _l			
60	0.048 at V _{GS} = 10 V	4.2	4.9		
00	0.060 at V _{GS} = 4.5 V	3.6	4.5		

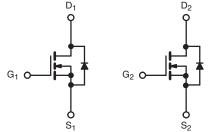
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Trench Power MOSFET
- 100 % R_q and UIS Tested
- Compliant to RoHS Directive 2002/95/EC



APPLICATIONS

- CCFL Inverter
- DC/DC Converter
- HDD



N-Channel MOSFET

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T	$_{\rm A}$ = 25 °C, unless other	rwise noted)			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V_{DS}	60	V		
Gate-Source Voltage	V_{GS}	± 20]		
	T _C = 25 °C		4.2		
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C	I _D	3.6		
Continuous Brain Guiterit (1) = 130 G)	T _A = 25 °C	טי	4.0 ^{b, c}		
	T _A = 70 °C	1	3.0 ^{b, c}		
Pulsed Drain Current (10 μs Pulse Width)		I _{DM}	16	А	
Source-Drain Current Diode Current	$T_C = 25 ^{\circ}C$. I _S	2.6		
Source-Drain Guitent blode Guitent	T _A = 25 °C		1.6 ^{b, c}		
Pulsed Source-Drain Current	I _{SM}	16			
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	10		
Single Pulse Avalanche Energy	L = 0.1 IIII1	E _{AS}	5		
	$T_C = 25 ^{\circ}C$		2.8		
Maximum Power Dissipation	T _C = 70 °C	. P _D	1.8	w	
Maximum i ower bissipation	T _A = 25 °C		2 ^{b, c}		
	T _A = 70 °C		1.28 ^{b, c}		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Тур.	Max.	Unit		
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	49	62.5	°C/W		
Maximum Junction-to-Foot (Drain)	Steady-State	R_{thJF}	30	40	0/ **		

Notes:

- a. Based on T_C = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under steady state conditions is 120 °C/W.



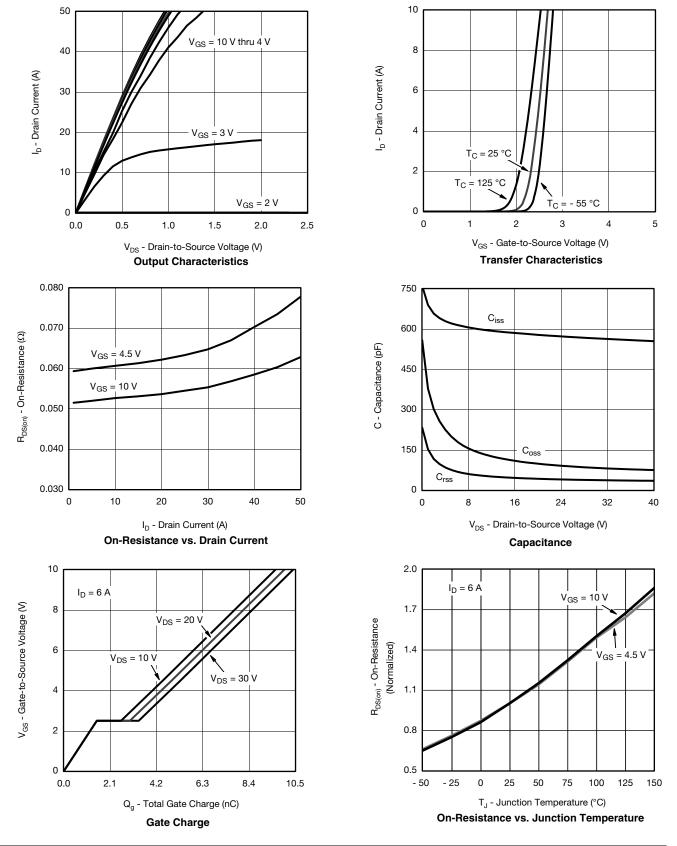
Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	_S /T _J I _D = 250 μA		49		m\//°(
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	1 _D = 250 μΑ		- 5.2		mV/°C
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.2		2.5	V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			100	nA
7 0	1	V _{DS} = 60 V, V _{GS} = 0 V			1	μΑ
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V, T _J = 55 °C			10	
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	20			Α
5 1 2 2 2 2 1 1 1 h	В	V _{GS} = 10 V, I _D = 4.0A		0.048		Ω
Drain-Source On-State Resistance ^b	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 3.0 \text{A}$		0.060		
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 4.0A		35		S
Dynamic ^a						
Input Capacitance	C _{iss}			580		pF
Output Capacitance	C _{oss}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, I_{D} = 1 \text{ MHz}$		100		
Reverse Transfer Capacitance	C _{rss}] [42		
Total Gate Charge	Qg	V _{DS} = 30 V, V _{GS} = 10 V, I _D = 4.0 A		10	15	nC
				4.9	7.4	
Gate-Source Charge	Q _{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 4.0 \text{ A}$		1.5		
Gate-Drain Charge	Q_{gd}]		1.5		
Gate Resistance	R_g	f = 1 MHz	0.6	2.7	5.4	Ω
Turn-On Delay Time	t _{d(on)}			7	14	
Rise Time	t _r	$V_{DD} = 30 \text{ V}, R_{L} = 2 \Omega$		9	18	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 4.0 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		16	32	
Fall Time	t _f]		8	16	
Turn-On Delay Time	t _{d(on)}			12	24	ns
Rise Time	t _r	$V_{DD} = 20 \text{ V}, R_L = 2 \Omega$		10	20	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 7.0 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		13	26	
Fall Time	t _f]		8	16	
Drain-Source Body Diode Characteristi	cs					
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			2.6	
Pulse Diode Forward Current ^a	I _{SM}				50	A
Body Diode Voltage	V _{SD}	I _S = 3 A		0.77	1.2	V
Body Diode Reverse Recovery Time	t _{rr}			15	30	ns
Body Diode Reverse Recovery Charge Q _{rr}		I _F = 5 A, dl/dt = 100 A/μs, T _J = 25 °C		7.5	15	nC
Reverse Recovery Fall Time	t _a	$\frac{1}{1} = 3 \text{ A}, \text{ u/u} = 100 \text{ A/}\mu\text{s}, \text{ I}_{\text{J}} = 25 \text{ C}$		9		ns
Reverse Recovery Rise Time	t _b	j		6		

Notes:

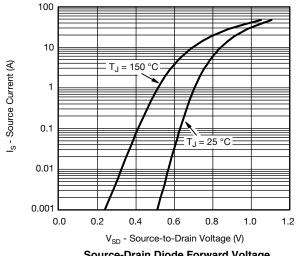
- a. Guaranteed by design, not subject to production testing. b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.

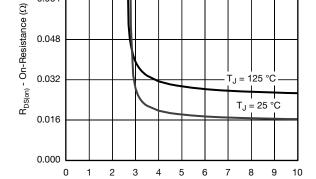
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.











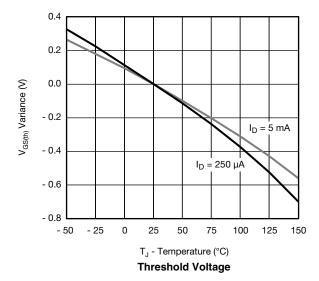
0.080

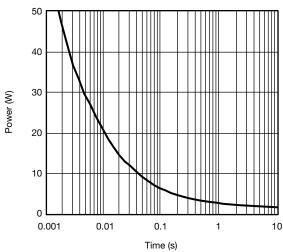
0.064

 $I_D = 4.0 A$

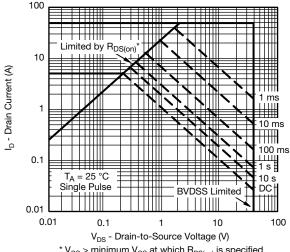
 V_{GS} - Gate-to-Source Voltage (V) On-Resistance vs. Gate-to-Source Voltage







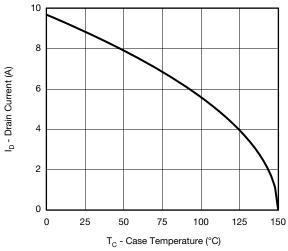
Single Pulse Power, Junction-to-Ambient



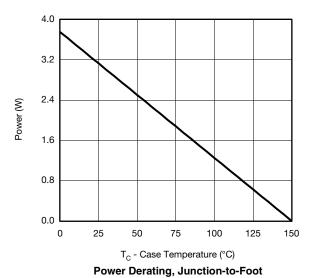
* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

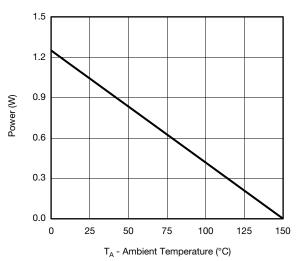
Safe Operating Area





Current Derating*

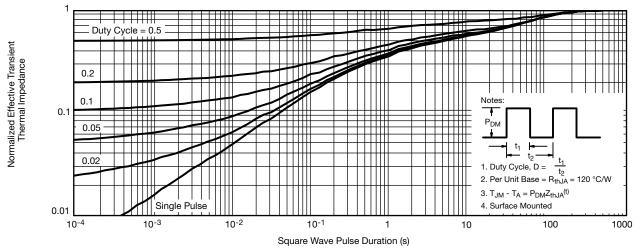




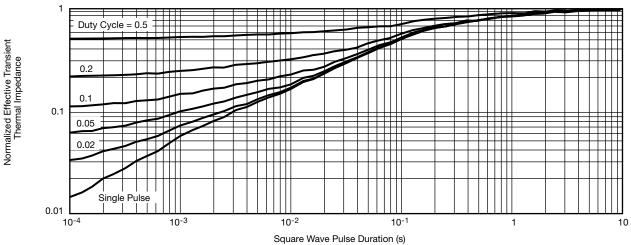
Power Derating, Junction-to-Ambient

 $^{^{\}star}$ The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient

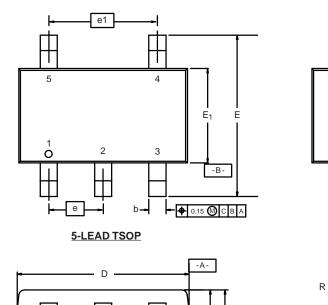


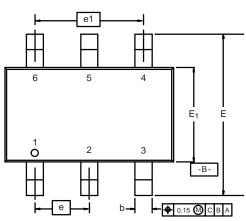
Normalized Thermal Transient Impedance, Junction-to-Foot



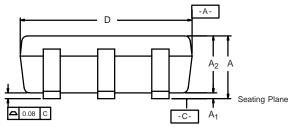
TSOP: 5/6-LEAD

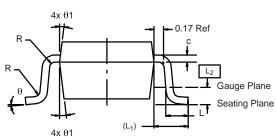
JEDEC Part Number: MO-193C





6-LEAD TSOP

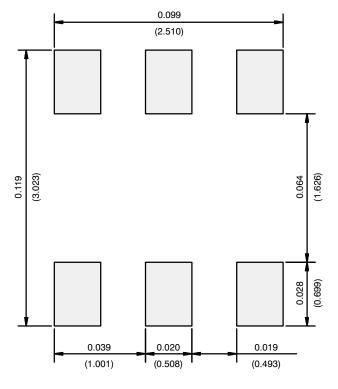




	MILLIMETERS			INCHES			
Dim	Min	Nom	Max	Min	Nom	Max	
Α	0.91	-	1.10	0.036	-	0.043	
A ₁	0.01	-	0.10	0.0004	-	0.004	
A ₂	0.90	-	1.00	0.035	0.038	0.039	
b	0.30	0.32	0.45	0.012	0.013	0.018	
С	0.10	0.15	0.20	0.004	0.006	0.008	
D	2.95	3.05	3.10	0.116	0.120	0.122	
Е	2.70	2.85	2.98	0.106	0.112	0.117	
E ₁	1.55	1.65	1.70	0.061	0.065	0.067	
е		0.95 BSC		0.0374 BSC			
e ₁	1.80	1.90	2.00	0.071	0.075	0.079	
L	0.32	-	0.50	0.012	-	0.020	
L ₁	0.60 Ref			0.024 Ref			
L ₂	0.25 BSC			0.010 BSC			
R	0.10	-	-	0.004	-	-	
θ	0°	4°	8°	0°	4°	8°	
θ_1	7° Nom			7° Nom			
ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540							



RECOMMENDED MINIMUM PADS FOR TSOP-6



Recommended Minimum Pads Dimensions in Inches/(mm)



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